

**Super-junction Power Mosfet**

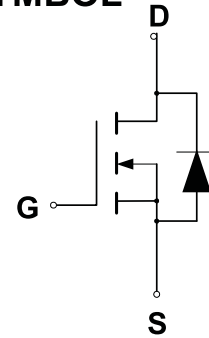
**Feature**

- 650V,80A  
 $R_{DS(ON)} < 41m\Omega @ V_{GS}=10V$
- Ultra-fast body diode
- Good Reliability
- Fast switching speed
- Extremely low losses due to very  $E_{on}$  and  $E_{off}$
- Qualified for industrial grade applications according to JEDEC
- RoHs compliant

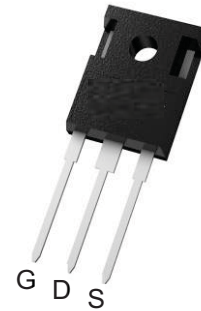
**Application**

- Switch Mode Power Supply (SMPS )
- Uninterruptible Power Supply (UPS )
- Power Factor Correction (PFC)
- Charge
- Halogen-free

**SYMBOL**



TO-247-3L



**Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
80N650	RM80N650T7	TO-247-3L	-	-	600 per box

**ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Continuous Drain Current ( $T_a = 25^\circ\text{C}$ )	$I_D$	80	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	240	A
Avalanche Current (Single pulse) <sup>(1)</sup>	$I_{AS}$	16	A
Single Pulsed Avalanche Energy <sup>(2)</sup>	$E_{AS}$	1280	mJ
Power Dissipation	$P_D$	465	W
Thermal Resistance from Junction to Ambient <sup>(4)</sup>	$R_{\theta JA}$	61	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55~ +150	$^\circ\text{C}$

## MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^{\circ}\text{C}$ unless otherwise noted)

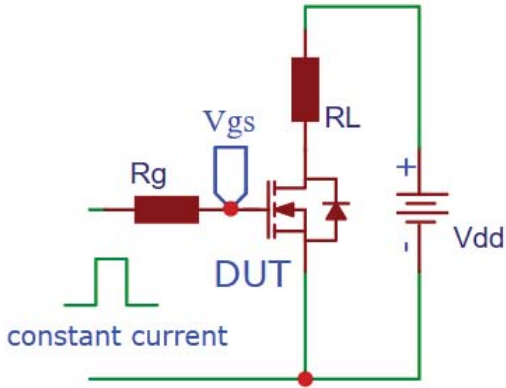
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	650	-	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^{\circ}\text{C}$	-	-	10	mA
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 150^{\circ}\text{C}$	-	1	-	
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 2mA$	3.5	4	4.5	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A, T_J = 25^{\circ}\text{C}$	-	37	41	m $\Omega$
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A, T_J = 150^{\circ}\text{C}$	-	93	-	m $\Omega$
Gate Resistance	$R_G$	f=1.0MHZ open drain	-	6	-	$\Omega$
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 50V, V_{GS} = 0V, f = 100KHz$	-	9886	-	pF
Output Capacitance	$C_{oss}$		-	4201	-	
Reverse Transfer Capacitance	$C_{rss}$		-	4.3	-	
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 400V, I_D = 40A,$ $R_G = 2\Omega, V_{GS} = 10V$	-	46.8	-	ns
Turn-on rise time	$t_r$		-	56.8	-	
Turn-off delay time	$t_{d(off)}$		-	194.4	-	
Turn-off fall time	$t_f$		-	41.6	-	
Total Gate Charge	$Q_g$	$V_{DS} = 400V, I_D = 40A,$ $V_{GS} = 10V$	-	191.6	-	nC
Gate-Source Charge	$Q_{gs}$		-	48.2	-	
Gate-Drain Charge	$Q_{gd}$		-	69.6	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	$V_{DS}$	$V_{GS} = 0V, I_S = 1A$	-	-	1.3	V
Peak Reverse Recovery Current	$I_{rrm}$	$V_R = 400V, I_F = 40A, di_F/dt = 100A/\mu s$	-	8.7	-	A
Reverse Recovery Time	$Q_{rr}$		-	0.832	-	$\mu\text{C}$
Reverse Recovery Charge	$T_{rr}$		-	146.4	-	ns

### Notes:

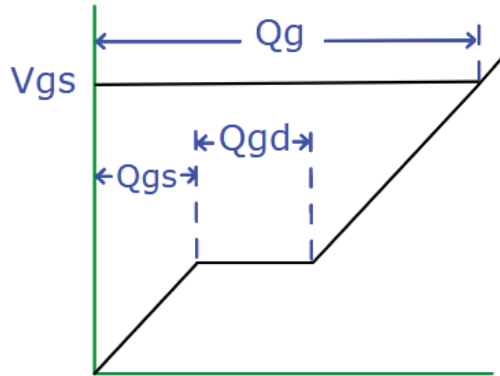
1. Repetitive Rating: pulse width limited by maximum junction temperature
2. EAS Condition:  $T_J = 25^{\circ}\text{C}, V_{DD} = 50V, R_G = 25\Omega, L = 10mH$
3. Identical low side and high side switch with identical  $R_G$

## Test Circuits ( $T_j = 25^\circ\text{C}$ )

Gate Charge test circuit

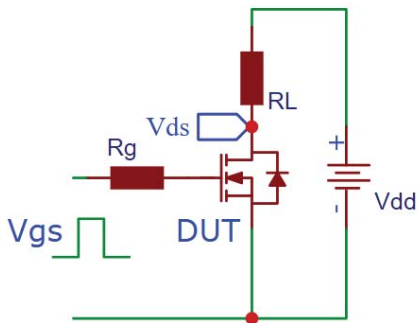


Gate Charge waveform

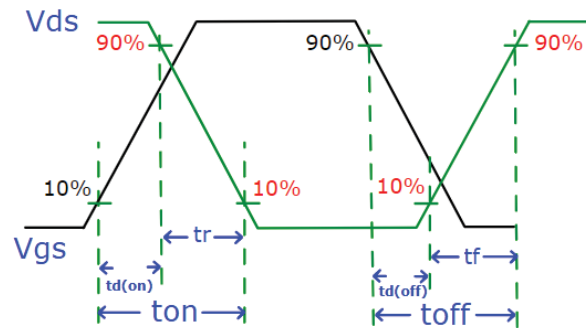


**Table 1 Gate Charge Test Circuit and Waveform**

Switching Time test circuit

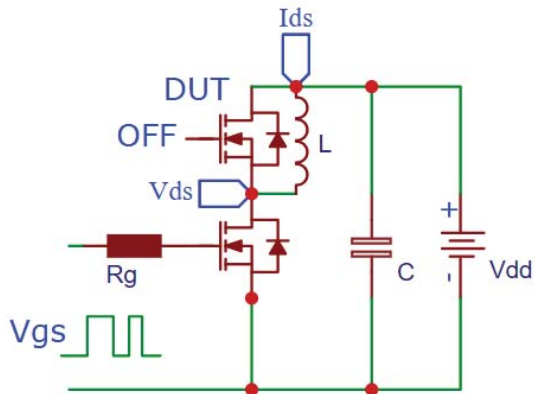


Switching Time waveform

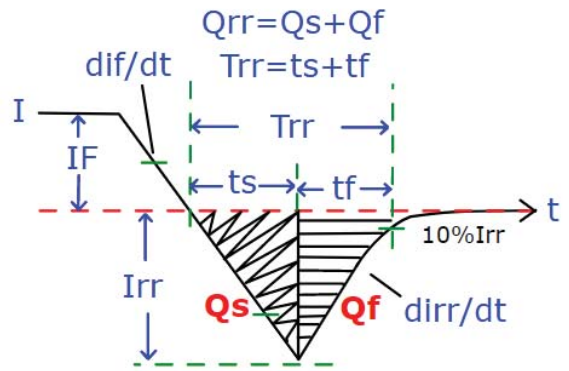


**Table 2 Switching Time Test Circuit and Waveform**

Diode Recovery test circuit

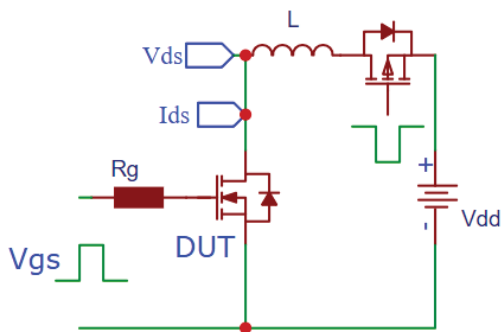


Diode Recovery waveform

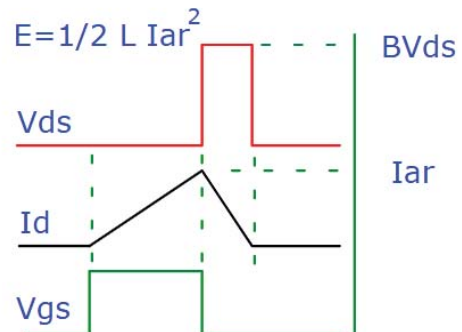


**Table 3 Diode Recovery Test Circuit and Waveform**

Unclamped inductive load test circuit

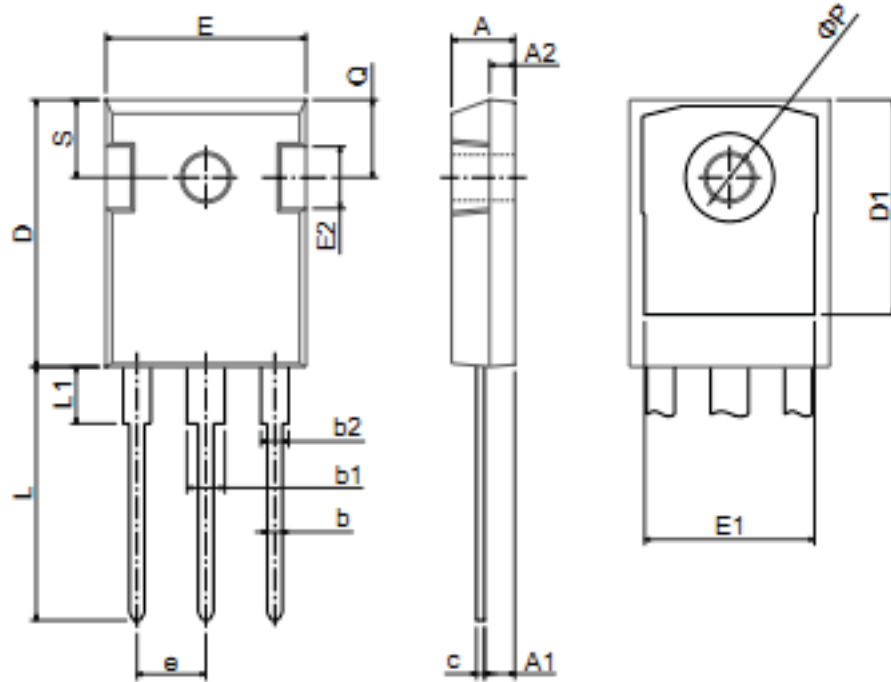


Unclamped inductive waveform



**Table 4 Unclamped\_inductive Test Circuit and Waveform**

# TO-247 Package Information



Dimension	Min(mm)	Max(mm)
A	4.70	5.31
A1	2.20	2.60
A2	1.50	2.49
b	0.99	1.40
b1	2.59	3.43
b2	1.65	2.39
c	0.38	0.89
D	20.30	21.46
D1	13.08	-
E	15.45	16.26
E1	13.06	14.02
E2	4.32	5.49
e	5.45BSC	
L	19.81	20.57
L1	-	4.50
ΦP	3.50	3.70
Q	5.38	6.20
S	6.15BSC	

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